

ERB12JGP

SINTERED GLASS JUNCTION PLASTIC RECTIFIER

VOLTAGE: 600V

CURRENT: 2.0A



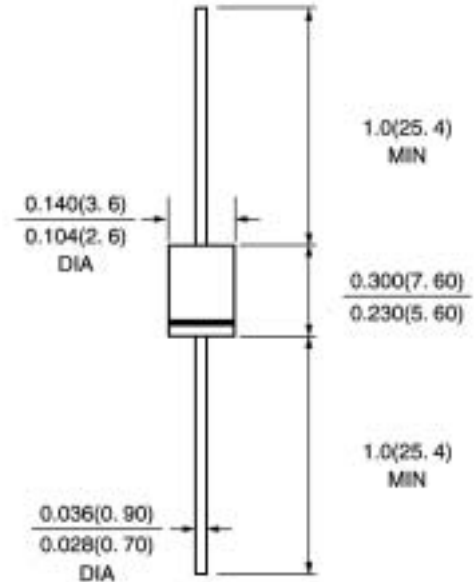
FEATURE

High temperature metallurgically bonded construction
Sintered glass cavity free junction
Capability of meeting environmental standard of MIL-S-19500
High temperature soldering guaranteed
350°C /10sec/0.375"lead length at 5 lbs tension
Operate at Ta =55°C with no thermal run away
Typical Ir<0.1µA

MECHANICAL DATA

Terminal: Plated axial leads solderable per MIL-STD 202E, method 208C
Case: Molded with UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: color band denotes cathode
Mounting position: any

DO-15\DO-204AC



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

	SYMBOL	ERB12JGP	units
Maximum Recurrent Peak Reverse Voltage	Vrrm	600	V
Maximum RMS Voltage	Vrms	420	V
Maximum DC blocking Voltage	Vdc	600	V
Maximum Average Forward Rectified Current 3/8"lead length at Ta =55°C	If(av)	2.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	Ifsm	65.0	A
Maximum Instantaneous Forward Voltage at 2.0A	Vf	1.1	V
Maximum full load reverse current full cycle Average at 55°C	Ir(av)	100.0	µA
Maximum DC Reverse Current Ta =25°C at rated DC blocking voltage	Ir	5.0	µA
Typical Reverse Recovery Time (Note 1)	Trr	2.5	µS
Typical Junction Capacitance (Note 2)	Cj	40.0	PF
Typical Thermal Resistance (Note 3)	R(ja)	25.0	°C /W
Storage and Operating Junction Temperature	Tstg, Tj	-65 to +175	°C

Note:

1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
3. Thermal Resistance from Junction to Ambient at 3/8"lead length, P.C. Board Mounted

RATINGS AND CHARACTERISTIC CURVES ERB12JGP

FIG. 1 - FORWARD CURRENT DERATING CURVE

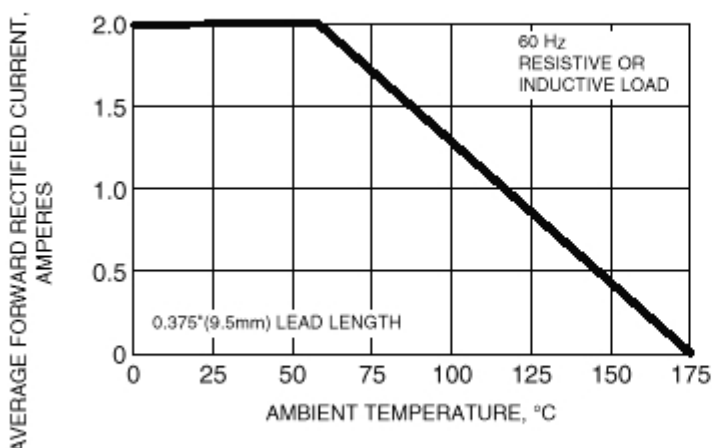


FIG. 2 - MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

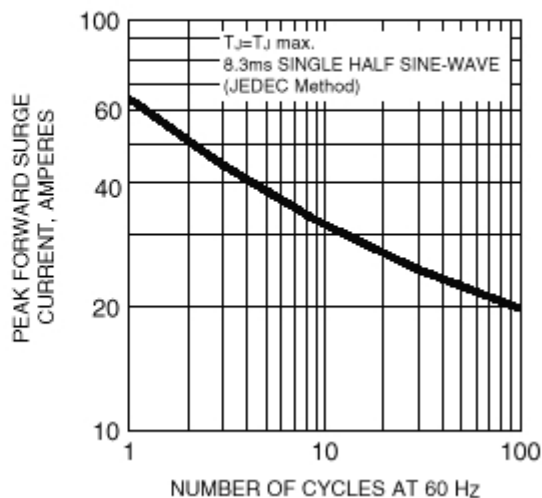


FIG. 3 - TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

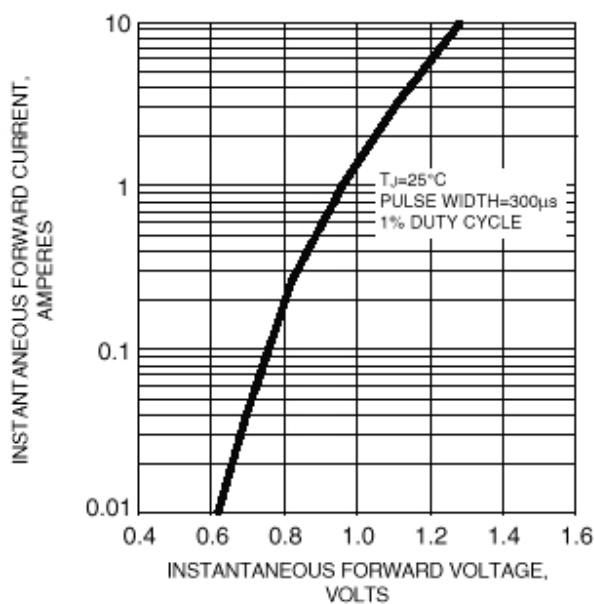


FIG. 4 - TYPICAL REVERSE CHARACTERISTICS

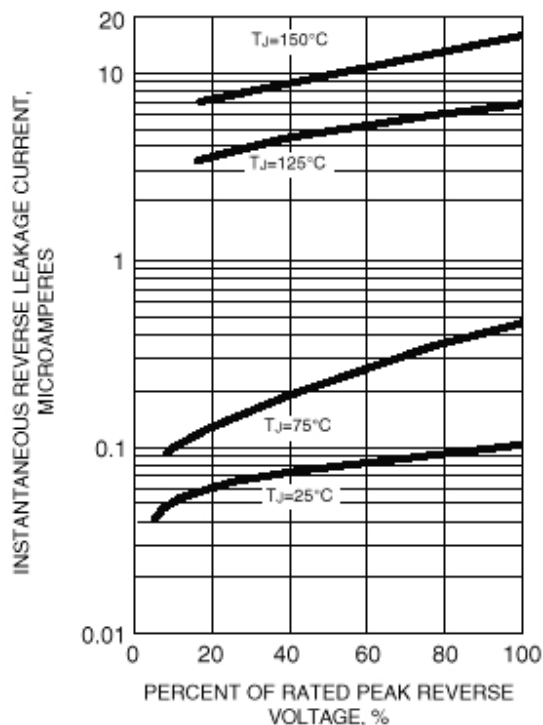


FIG. 5 - TYPICAL JUNCTION CAPACITANCE

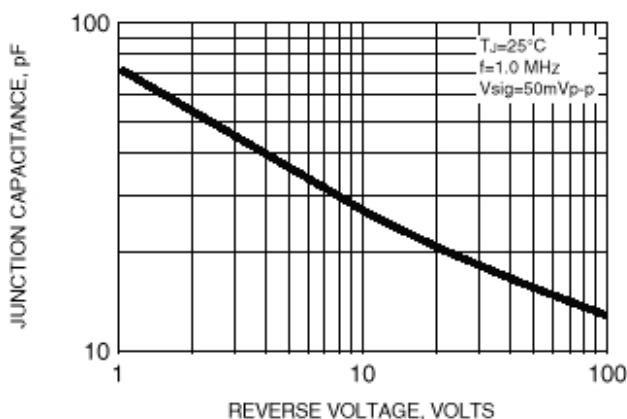


FIG. 6 - TYPICAL TRANSIENT THERMAL IMPEDANCE

